

Final Product Change Notification

201906005F01

Issue Date: 30-Jun-2019
Effective Date: 01-Oct-2019

Here's your personalized quality information concerning products Digi-Key purchased from Nexperia. For detailed information we invite you to view this notification online



Change Category

- | | | | | |
|--|--|--|---|---|
| <input type="checkbox"/> Wafer Fab Process | <input type="checkbox"/> Assembly Process | <input type="checkbox"/> Product Marking | <input type="checkbox"/> Test Location | <input type="checkbox"/> Design |
| <input type="checkbox"/> Wafer Fab Materials | <input checked="" type="checkbox"/> Assembly Materials | <input type="checkbox"/> Mechanical Specification | <input type="checkbox"/> Test Process | <input type="checkbox"/> Errata |
| <input checked="" type="checkbox"/> Wafer Fab Location | <input type="checkbox"/> Assembly Location | <input type="checkbox"/> Packing/Shipping/Labeling | <input type="checkbox"/> Test Equipment | <input type="checkbox"/> Electrical spec./Test coverage |

LFPAK56 Dual Sourcing of Fabrication and BOM Update

Details of this Change

To meet customer requirements for second sourcing of wafer production, and direct material sources as a business contingency, Nexperia will supply T3 LFPAK products from 2 diffusion facilities (Manchester and Hamburg), assembly will continue to be carried out at Cabuyao.

The release of these parts will include robustness enhancements to the products, the former T3 robust metal and assembly robust clip.

Why do we Implement this Change

To meet Customer requirements for second sourcing as a business contingency. From implementation date Nexperia will have increased supply security provided by multiple wafer manufacturing locations for our T3 LFPAK56 portfolio

Identification of Affected Products

Top side marking
 Marking will indicate the source of diffused wafers and the Assembly/Test Location

Product Availability

Sample Information

Samples are available upon request

Production

Planned first shipment 01-Oct-2019

Impact

no impact to the product's functionality anticipated.

Data Sheet Revision

No impact to existing datasheet

Disposition of Old Products

Existing inventory will be shipped until depleted

Timing and Logistics

Your acknowledgement of this change, conform JEDEC J-STD-046, is expected till 30-Jul-2019. Lack of acknowledgement of the PCN constitutes acceptance of the change.

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact Nexperia "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local Nexperia Sales Support team.

At Nexperia B.V. we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

About Nexperia B.V.

We at Nexperia are the efficiency semiconductor company. We deliver over 90 billion products a year and as such service thousands of global customers, both directly and through our extensive network of channel partners. We are at the heart of billions of electronic devices in the Automotive, Mobile, Industrial, Consumer, Computing, and Communication Infrastructure segments.

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Affected Part Numbers

BUK9Y19-55B,115
BUK9Y104-100B,115
BUK9Y40-55B,115
BUK9Y30-75B,115
BUK7Y13-40B,115
BUK9Y11-30B,115
BUK9Y14-40B,115
BUK9Y53-100B,115
BUK7Y18-75B,115
BUK7Y28-75B,115
BUK9Y19-75B,115
BUK9Y58-75B,115
BUK7Y12-55B,115
BUK9Y12-55B,115
BUK7Y08-40B,115
BUK9Y09-40B,115
BUK9Y27-40B,115
BUK7Y20-30B,115
BUK9Y07-30B,115
BUK9Y22-30B,115
BUK7Y102-100B,115
BUK7Y53-100B,115